





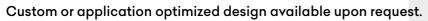
## Key applications:

- Surface and volume micro- and nano- structuring
- Femtosecond laser ablation (FSLA)
- · Laser grooving
- Multiphoton polymerization (MPP) I direct laser writing (DLW)
- Laser cutting & drilling
- · Micromachining on optical fibers

# Technical specifications



Recommended materials	All materials: glass, sapphire, silicon, ceramics, meta	II, plastic, optical fibers etc.
Laser	High power ultrashort pulse IR, Green, UV laser	
Optical path selection	Automated	
Samples size	Compatible with up to 160 mm x 160 mm designs	
Smallest feature size	200 nm	
Positioning system	XYZ mechanical axes, positioning accuracy +- 0.3 µn level patterning	n featuring continuous wafer
Scanning system	Galvo system for all laser wavelengths	
Vision	Real-time visualisation and positioning camera with	feature recognition
Metrology	Integrated microscope	
Sample handling	Manual with automatic alignment	
Holder	Sample holder for flat structures (vacuum suction ba for optical fibers	sed) with additional holder
Fume extraction system	Included	
Accessories	Power control, polarization state control	
Software	Entire system control via single GUI.	
Supported file formats	- 2D/3D model import: STL, DXF, DWG, AMF, PLT, FAE - Bitmap support: BMP, GIF, JPG, JPEG, PNG - Text files as a table array: TXT, RTF, TE	3
Construction	Granite base with passive vibrations isolation, built a stand-alone design)	n optical table(optional
Cooling	Water cooled laser, air cooled system and electrical	cabinet
Dimensions, mm (L x W x H)	1500 x 1350 x 1400	
Weight	1100 kg	
Power supply	2x 220 VAC, 16 A	
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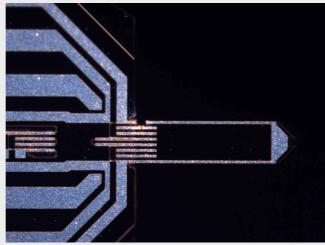
## **FemtoLAB**

WORKSHOP OF PHOTONICS

Working in the femtosecond laser field and exploring various research areas, it is crucial to have machine flexibility to tune it for different applications.

With an extensive background in process development Workshop of Photonics understands how critical it is to match the demand of different research teams involved and enable their all needs.

Herewith we offer FemtoLAB – a femtosecond laser micromachining workstation - for a universal use.



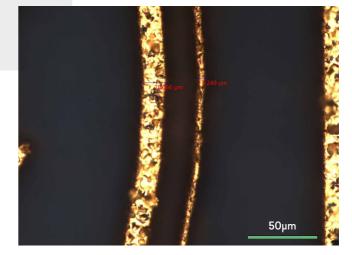
Laser cutting. Narrow and wide cuts of a silicon cantilever



Laser marking. Written directly inside the object (glass) by making refractive index irregularities without damaging the surface







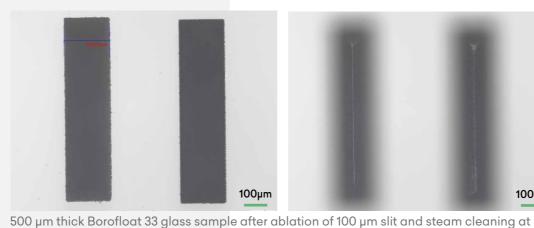
Laser marking I selective gold layer removal. Gold, thickness ~10  $\mu m$ , bottom layer ceramic substrate

## **FemtoLAB**

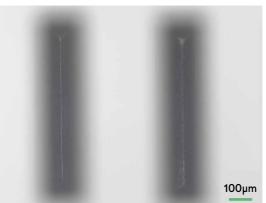


### Benefit from:

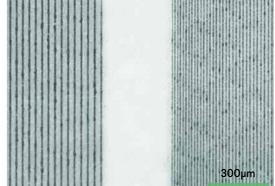
- Finest resolution
- Complex 3D objects
- · Cost effective
- Small footprint



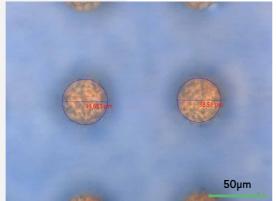
20x, top view surface and bottom of processing

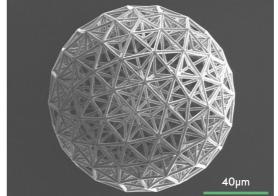


Surface and volume micro- and nano-structuring



50µm





Blind holes drilling in multi layered sandwich like substrate - 25 µm thickness dielectric layer (blue color) drilling to gold layer (yellow color)

Multiphoton polymerization (MPP)

## **FemtoLAB**

# A perfect choice for scientific laboratories and R&D centers

"After 10 years of experience, working with your femtosecond system, my honest opinion is more than positive, and we are satisfied with the product. Compared to other systems, ours "full optional facility" allows us to explore valuable processing on many different materials. This is an added value for the research in IIT!"

Luigino Criante Technology Researcher

Istituto Italiano di Tecnologia Genoa, Italy





















### 18+ years of expertise

in femtosecond laser micromachining with high focus on glass



### Full - service solution

Prototyping Scaling production Laser system development



### 6 in-house and 2 licensed patents

enabling cutting - edge technologies



#### Continuous R&D studies

with academic and research partners

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